

INFORMATION DISCLOSURE STATEMENT

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|-----------|---|---|
| Applicant | : | Masuda et al. |
| App. No | : | 10/564,510 |
| Filed | : | January 12, 2006 |
| For | : | POSITIVE PHOTORESIST COMPOSITION AND METHOD OF FORMING RESIST PATTERN |
| Examiner | : | John S Y Chu |
| Art Unit | : | 1752 |

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

Enclosed for filing in the above-identified application is a PTO/SB/08 Equivalent listing 2 references to be considered by the Examiner. Also enclosed are 2 foreign patent references and/or non-patent literature as listed on the Information Disclosure Statement.

This Information Disclosure Statement is being filed before the mailing date of a final action and before the mailing date of a Notice of Allowance.

CERTIFICATION UNDER 37 C.F.R. § 1.97(e)(1)

I hereby certify that each item of information contained in this Statement was first cited in a communication from a foreign Patent Office in a counterpart foreign application not more than 30 days prior to the filing of this Information Disclosure Statement.

Thus, no fee is required as set forth in 37 C.F.R. § 1.97(c), however, the Commissioner is

Appl. No. : 10/564,510
Filed : January 12, 2006

Docket No. SHIGA7.036APC
Customer No. 20,995

hereby authorized to charge any additional fees which may be required or to credit any overpayment to Account No. 11-1410.

Respectfully submitted,

KNOBBE, MARTENS, OLSON & BEAR, LLP

Dated: 7/11/07

By: 

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| INFORMATION DISCLOSURE STATEMENT BY APPLICANT | | Application No. | 10/564,510 |
| | | Filing Date | January 12, 2006 |
| | | First Named Inventor | Masuda et al. |
| | | Art Unit | 1752 |
| (Multiple sheets used when necessary) | | Examiner | John S Y Chu |
| SHEET 1 OF 1 | | Attorney Docket No. | SHIGA7.036APC |

| U.S. PATENT DOCUMENTS | | | | | |
|-----------------------|----------|---|--------------------------------|-------------------------------|--|
| Examiner Initials | Cite No. | Document Number Number - Kind Code (if known) Example: 1,234,567 B1 | Publication Date MM-DD-YYYY | Name of Patentee or Applicant | Pages, Columns, Lines Where Relevant Passages or Relevant Figures Appear |

| FOREIGN PATENT DOCUMENTS | | | | | | |
|--------------------------|----------|--|--------------------------------|-------------------------------|--|----------------|
| Examiner Initials | Cite No. | Foreign Patent Document Country Code-Number-Kind Code Example: JP 1234567 A1 | Publication Date MM-DD-YYYY | Name of Patentee or Applicant | Pages, Columns, Lines Where Relevant Passages or Relevant Figures Appear | T ¹ |
| | 1 | JP 2001075272 | 03-23-2001 | Tokyo Ohka Kogyo Co., LTD | | ✓ |

| NON PATENT LITERATURE DOCUMENTS | | | | | | |
|---------------------------------|----------|---|--|--|--|----------------|
| Examiner Initials | Cite No. | Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published. | | | | T ¹ |
| | 2 | Office Action issued on June 12, 2007, in connection with Japanese Patent Application No. 2003-197873. | | | | |

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|--------------------|-----------------|
| Examiner Signature | Date Considered |
|--------------------|-----------------|

*Examiner: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

T¹ - Place a check mark in this area when an English language Translation is attached.